

PE9308

Product Description

The PE9308 is a high-performance dynamic UltraCMOS™ prescaler ideal for Ku band Transceiver applications. It has a fixed divide ratio of 4 with an operating frequency range of 4.0 GHz to 13.5 GHz. The PE9308 operates on a nominal 2.6 V supply and draws only 15 mA. It is packaged in a small 8-lead Flat Pack and is also available in Die form for Hybrid application.

The PE9308 is manufactured in Peregrine's patented Ultra Thin Silicon (UTSi©) CMOS process, offering the performance of GaAs with the economy and integration of conventional CMOS.

Figure 1. Functional Schematic Diagram

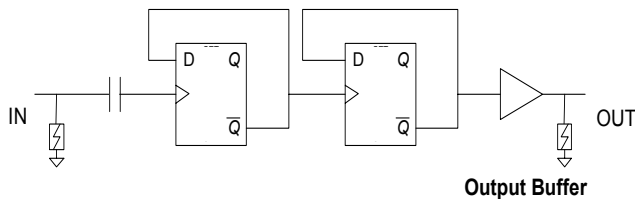


Figure 2. Package Type

8-lead CSOIC

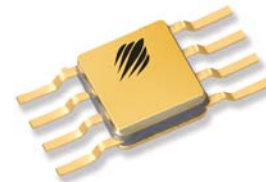
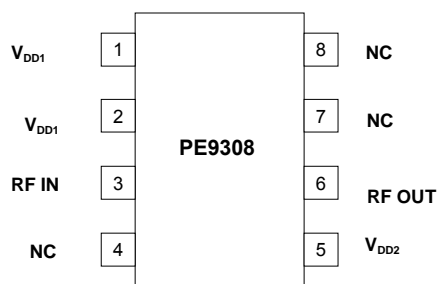


Table 1. Electrical Specifications ($Z_S = Z_L = 50 \Omega$)

$V_{DD} = 2.45 < V_{DD} < 2.75 \text{ V}$, $-40^\circ \text{ C} \leq T_A \leq 85^\circ \text{ C}$, unless otherwise specified

Parameter	Conditions	Minimum	Typical	Maximum	Units
Frequency		4000		13,500	MHz
Supply Voltage		2.45	2.6	2.75	V
Supply Current		8	15	20	mA
SSB Phase noise (PhN)	100 KHz Offset; Pin=0dBm		-120		dBc/Hz
Input Power (Pin)	$7.0 \text{ GHz} \leq F_{in} \leq 10.0 \text{ GHz}$	0		+10	dBm
	$4.0 \text{ GHz} < F_{in} \leq 7.0 \text{ GHz}$	+5		+10	dBm
Output Power (Pout)	$4.0 \text{ GHz} \leq F_{in} \leq 10.0 \text{ GHz}$	0			dBm

Figure 3. Pin Configuration (Top View)

Table 2. Pin Descriptions

Pin No.	Pin Name	Description
1	V _{DD1}	DC Supply Voltage
2	V _{DD1}	DC Supply Voltage
3	RF IN	RF Input
4	NC	Not connected
5	V _{DD2}	DC Supply Voltage
6	RF OUT	RF Output.
7	NC	Not connected
8	NC	Not connected

Table 3. Absolute Maximum Ratings

Symbol	Parameter/Conditions	Min	Max	Units
V _{DD}	DC Supply voltage		3.0	V
T _{ST}	Storage temperature range	-65	150	°C
T _{OP}	Operating temperature range	-40	85	°C
VESD	ESD voltage (Human Body Model)		250	V
P _{INMAX}	Maximum input power		14	dBm

Absolute Maximum Ratings are those values listed in the above table. Exceeding these values may cause permanent device damage. Exposure to absolute maximum ratings for extended periods may affect device reliability.

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified in Table 3.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

Device Functional Considerations

The PE9308 takes an input signal frequency from between 4.0 GHz to 13.5 GHz and produces an output signal frequency one-fourth that of the supplied input. In order for the prescaler to work properly, several conditions need to be adhered to. It is crucial that pins 1, 2 and 5 be supplied with a bypass capacitor to ground. In addition, the output signal (pins 6) needs to be ac coupled via an external capacitor as shown in the test circuit below.

The ground pattern on the board should be made as wide as possible to minimize ground impedance.

Figure 4. Test Circuit Block Diagram

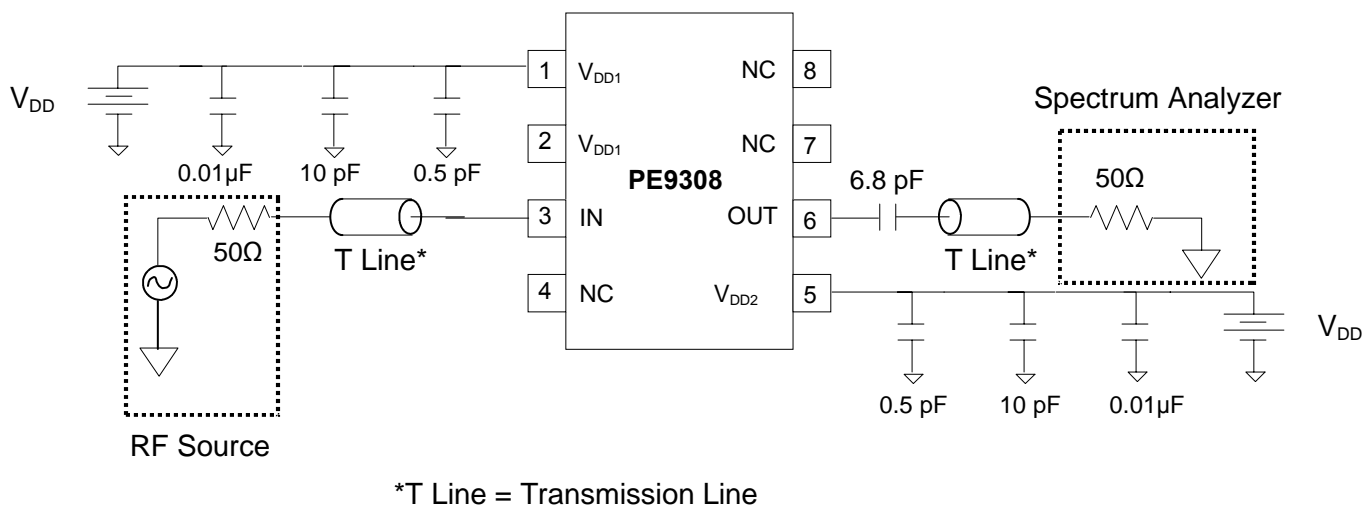


Figure 5. High Frequency System Application

The wideband frequency of operation of the PE9308 makes it an ideal part for use in a DBS down converter system.

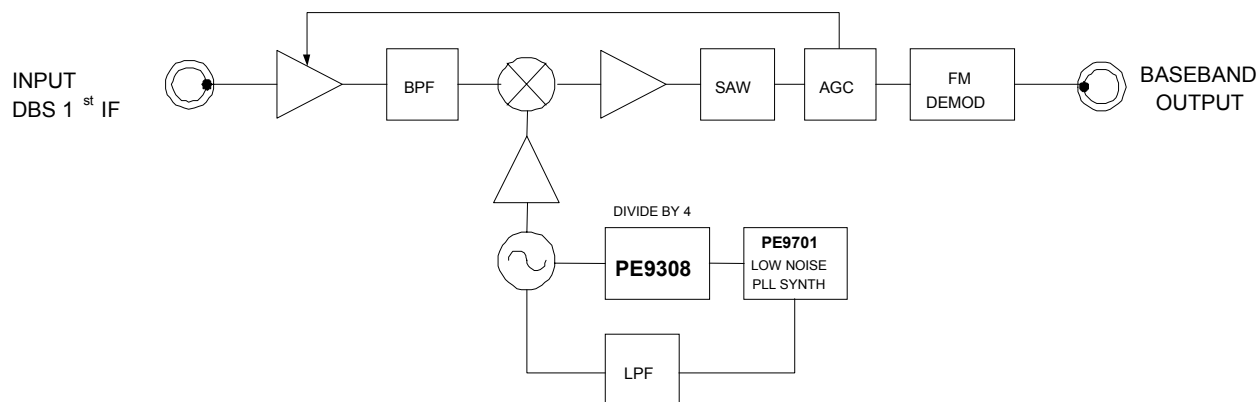


Figure 6: Input Power Sensitivity vs Input Frequency at Nominal Voltage, 25 °C

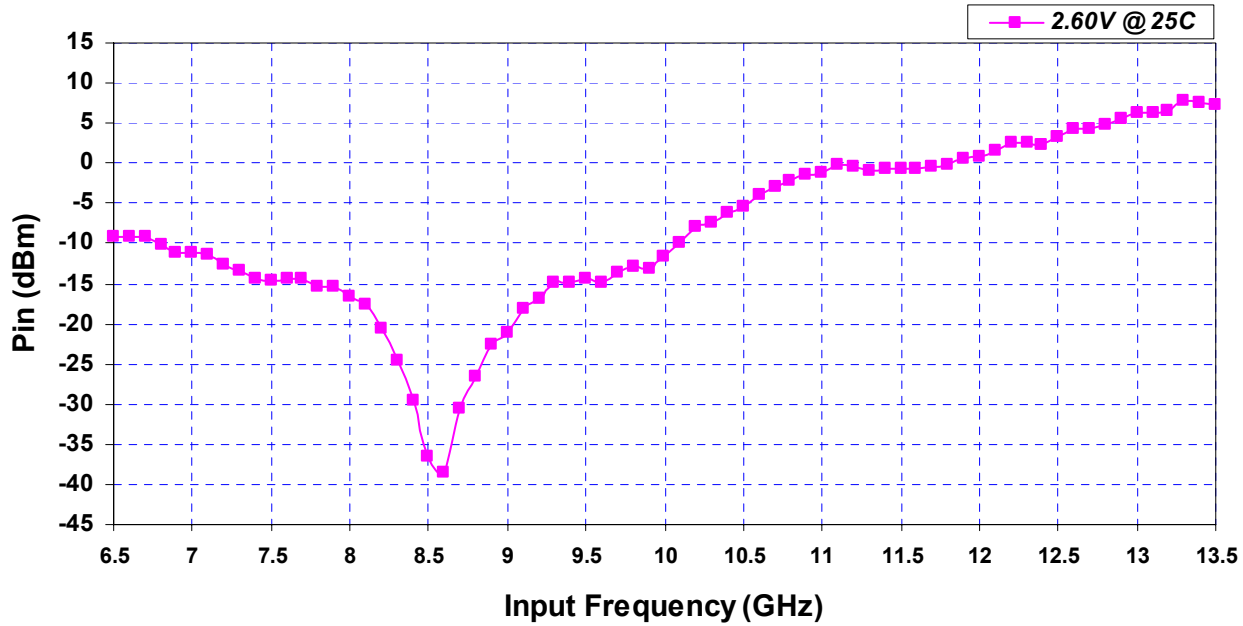
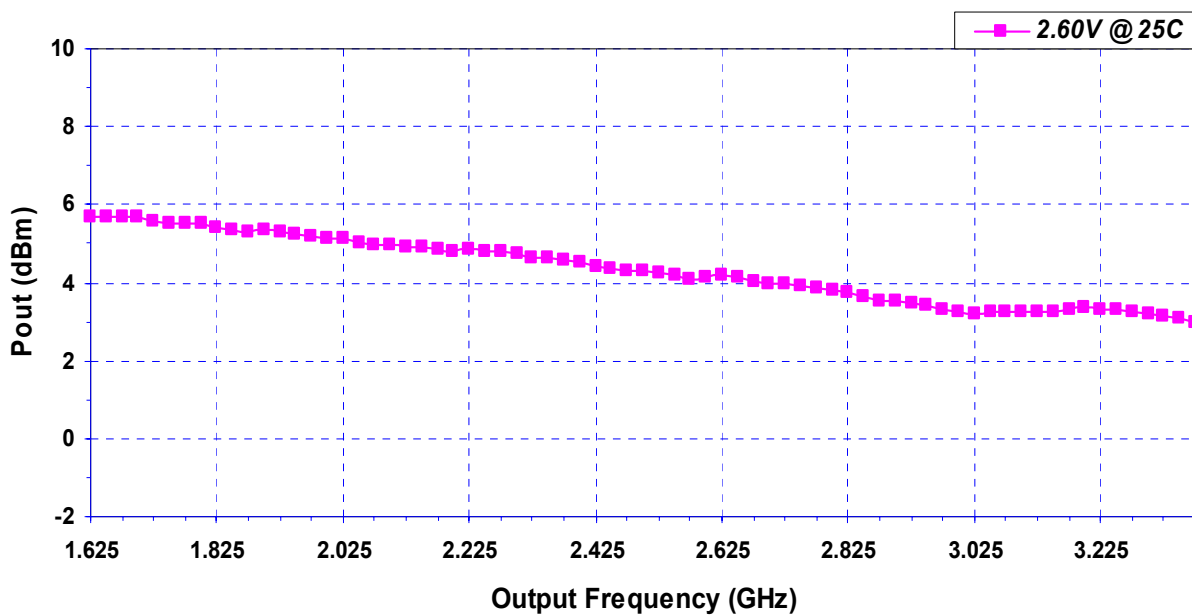


Figure 7: Output Power vs Output Frequency at Nominal Voltage, 25 °C



Evaluation Kit

The Ceramic SOIC Prescaler Evaluation Board was designed to help customers evaluate the PE9308 divide-by-4 prescaler. On this board, the device input (pin 3) is connected to the SMA connector J2 through a 50 Ω transmission line. The device output (pin 6) is connected to SMA connector J3 through a 50 Ω transmission line.

J1 provides DC power to the device via pin 1,2,4,5,7,8. Multiple decoupling capacitors (C4,5,8,9=10pF, C3,6,7,10=0.01uF) are used. It is the responsibility of the customer to determine proper supply decoupling for their design application. The board is constructed using 4 layers. The top and bottom layers are comprised of Rogers low loss 4350 material having a core thickness of 0.010"; while the internal layers are comprised of FR-4. The overall board thickness is 0.062".

Applications Support

If you have a problem with your evaluation kit or if you have applications questions call (858) 731-9400 and ask for applications support. You may also contact us by fax or e-mail:

Fax: (858) 731-9499

E-Mail: help@psemi.com

Figure 8. Evaluation Board Layouts

Peregrine Specification 101/0186

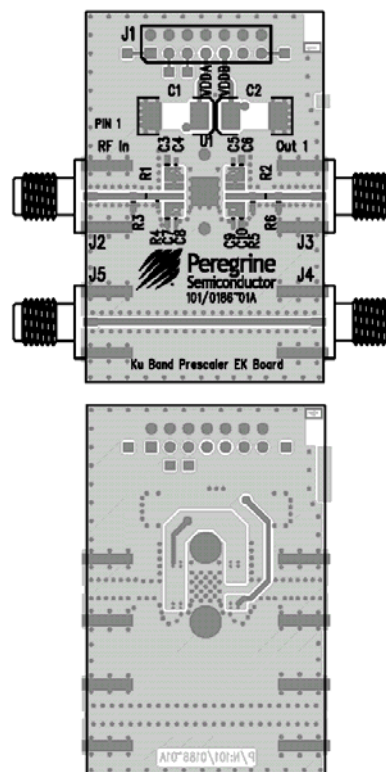


Figure 9. Evaluation Board Schematic

Peregrine Specification 102/0247

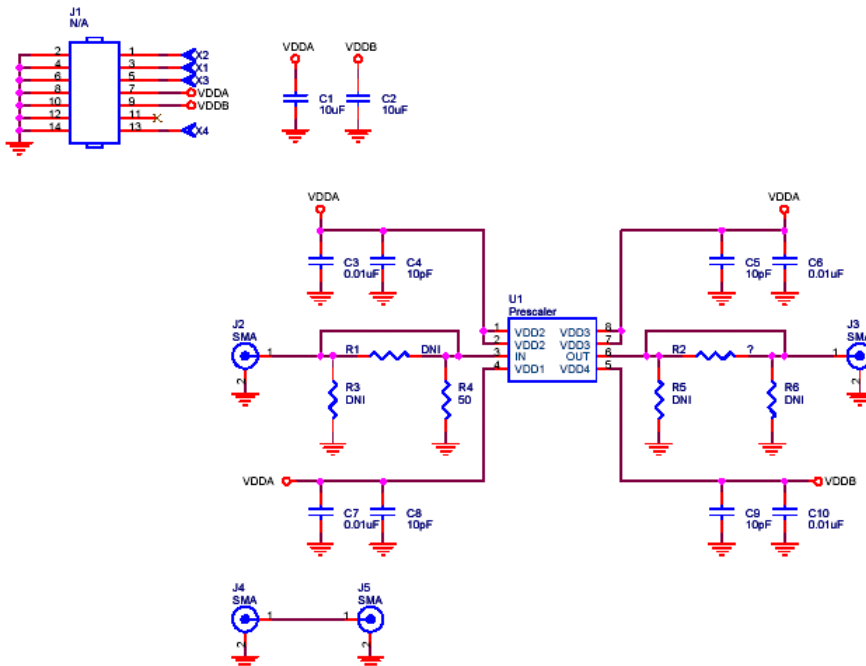
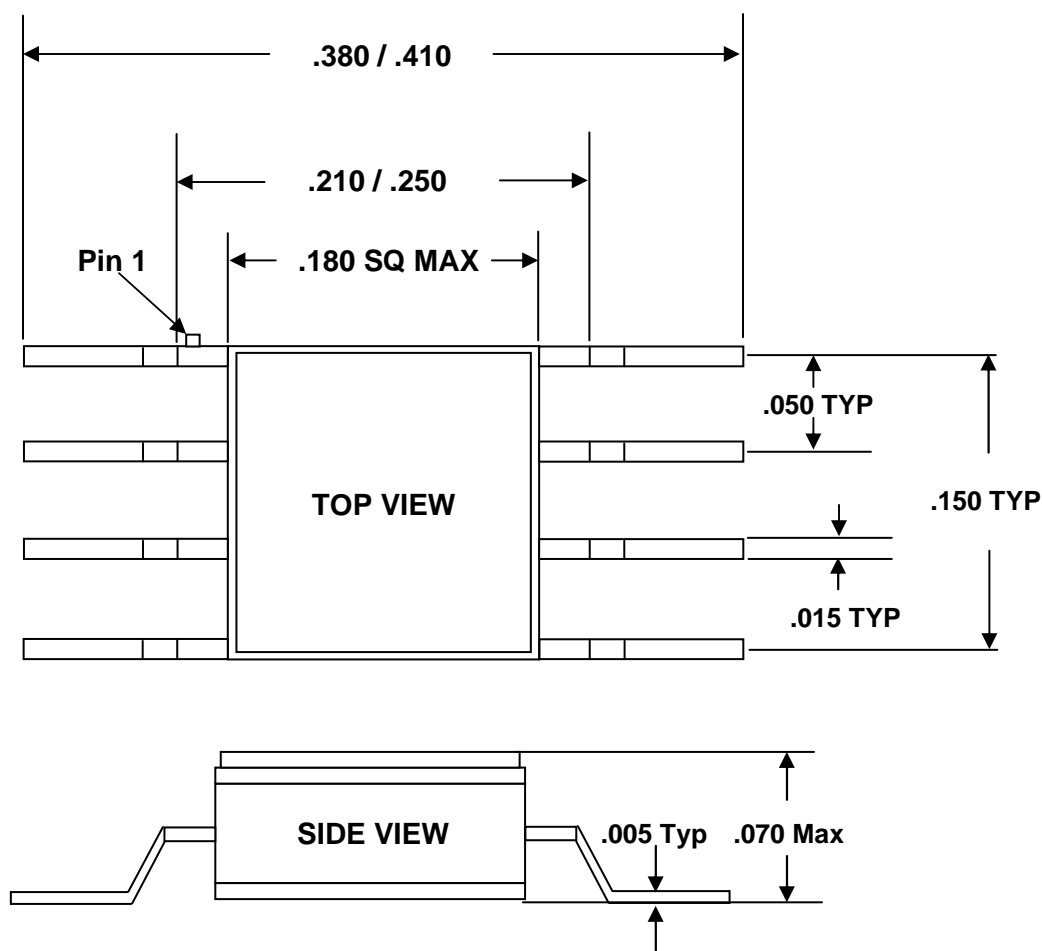


Figure 10. Package Drawing

8-lead CSOIC



ALL DIMENSIONS ARE IN INCHES
DRAWINGS ARE NOT TO SCALE

Table 4. Ordering Information

Order Code	Part Marking	Description	Package	Shipping Method
9308-01	9308	PE9308-08CFPJ-B Engineering Samples	8-lead FLAT PACK	50 / Tray
9308-11	9308	PE9308-08CFPJ-B Production Units	8-lead FLAT PACK	50 / Tray
9308-00	PE9308-EK	PE9308 Evaluation Kit	Evaluation Board	1 / Box

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Data Sheet Identification

Advance Information

The product is in a formative or design stage. The data sheet contains design target specifications for product development. Specifications and features may change in any manner without notice.

Preliminary Specification

The data sheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product.

Product Specification

The data sheet contains final data. In the event Peregrine decides to change the specifications, Peregrine will notify customers of the intended changes by issuing a DCN (Document Change Notice).

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